DISCRETE SEMICONDUCTORS

DATA SHEET

BYV29F, BYV29X series Rectifier diodes ultrafast

Product specification

October 2018



Rectifier diodes ultrafast

BYV29F, BYV29X series

FEATURES

- · Low forward volt drop
- · Fast switching
- · Soft recovery characteristic
- · High thermal cycling performance
- · Isolated mounting tab

SYMBOL



QUICK REFERENCE DATA

$$V_R = 300 \text{ V} / 400 \text{ V} / 500 \text{ V}$$
 $V_F \le 1.03 \text{ V}$ $I_{F(AV)} = 9 \text{ A}$ $t_{rr} \le 60 \text{ ns}$

GENERAL DESCRIPTION

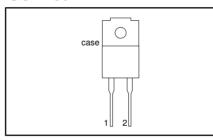
Ultra-fast epitaxial rectifier diodes intended for use in switched mode power supply output rectification, electronic lighting ballasts and high frequency switching circuits in general.

The BYV29F series is supplied in the SOD100 package. The BYV29X series is supplied in the SOD113 package.

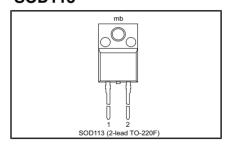
PINNING

PIN	DESCRIPTION		
1	cathode (k)		
2	anode (a)		
tab	isolated		

SOD100



SOD113



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.			UNIT
		BYV29F/BYV29X		-300	-400	-500	
$egin{array}{c} oldsymbol{V}_{RRM} \ oldsymbol{V}_{R} \end{array}$	Peak repetitive reverse voltage Continuous reverse voltage	$T_{hs} \le 138^{\circ}C^{1}$	-	300 300	400 400	500 500	V
I _{F(AV)}	Average forward current ²	square wave; $\delta = 0.5$; $T_{hs} \le 90 ^{\circ}\text{C}$	-		9		Α
I _{FSM}	Non-repetitive peak forward current	t = 10 ms t = 8.3 ms sinusoidal; with reapplied	-		100 110		A A
T _{stg}	Storage temperature Operating junction temperature	$V_{RRM(max)}$	-40 -		150 150		, C

 $¹ T_{hs}$ de-rating for thermal stability.

² Neglecting switching and reverse current losses

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ISOLATION LIMITING VALUE & CHARACTERISTIC

 T_{hs} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	Peak isolation voltage from all terminals to external heatsink	SOD100 package; R.H. ≤ 65%; clean and dustfree	1	-	1500	٧
V _{isol}	R.M.S. isolation voltage from all terminals to external heatsink	SOD113 package; f = 50-60 Hz; sinusoidal waveform; R.H. ≤ 65%; clean and dustfree	-	-	2500	V
C _{isol}	Capacitance from pin 2 to external heatsink	f = 1 MHz	-	10	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th j-hs}$ $R_{th j-a}$	heatsink	with heatsink compound without heatsink compound in free air.	- - -	- - 55	5.5 7.2 -	K/W K/W K/W

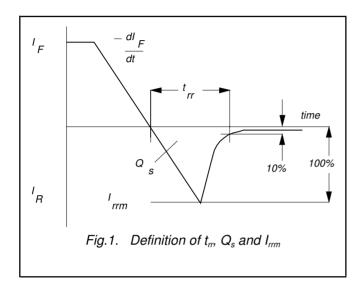
ELECTRICAL CHARACTERISTICS

T_i = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	$I_F = 8 \text{ A}; T_i = 150^{\circ}\text{C}$	-	0.90	1.03	V
•	ľ	$I_F = 8 \text{ A}$	-	1.05	1.25	V
		$I_{\rm F} = 20 \text{ A}$	-	1.20	1.40	V
I _R	Reverse current	$ V_R = V_{RRM} $	-	2.0	50	μΑ
		$V_{R} = V_{RRM}$; $T_{i} = 100 ^{\circ}$ C	-	0.1	0.35	mA
Q_s	Reverse recovery charge	$I_F = 2 \text{ A to } V_R \ge 30 \text{ V};$ $dI_F/dt = 20 \text{ A/}\mu\text{s}$	-	40	60	nC
t _{rr}	Reverse recovery time	$I_F = 1 \text{ A to } V_R \ge 30 \text{ V};$ $dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	50	60	ns
I _{rrm}	Peak reverse recovery current	$I_F = 10 \text{ A to } V_R \ge 30 \text{ V};$ $dI_F/dt = 50 \text{ A/}\mu\text{s}; T_i = 100^{\circ}\text{C}$	-	4.0	5.5	Α
V_{fr}	Forward recovery voltage	$I_F = 10 \text{ A}; dI_F/dt = 10 \text{ A}/\mu\text{s}$	-	2.5	-	V

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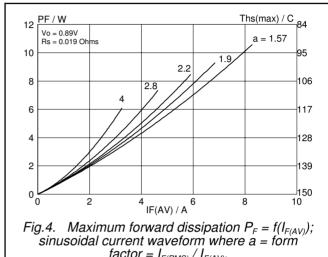
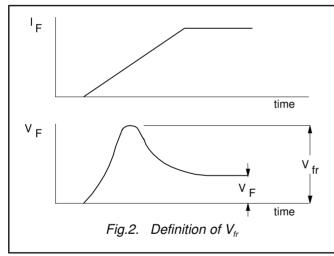
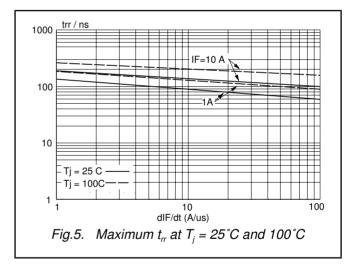
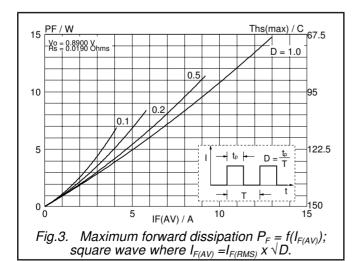
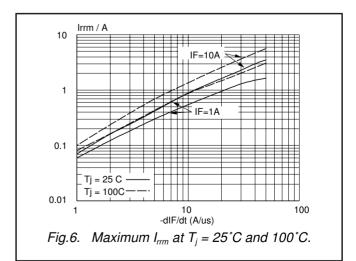


Fig.4. Maximum forward dissipation $P_F = f(I_{F(AV)})$; sinusoidal current waveform where a = form factor = $I_{F(RMS)} / I_{F(AV)}$.





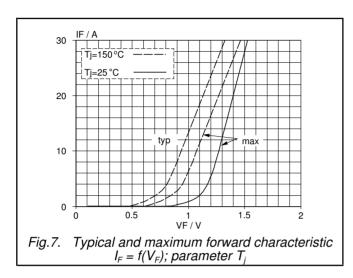


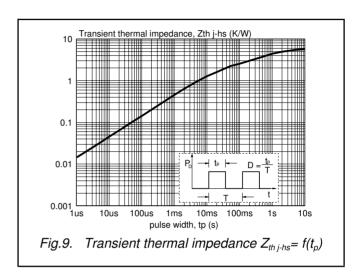


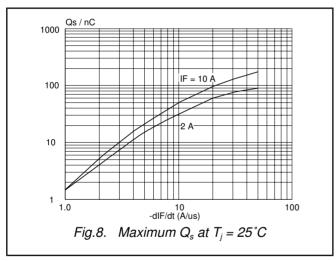
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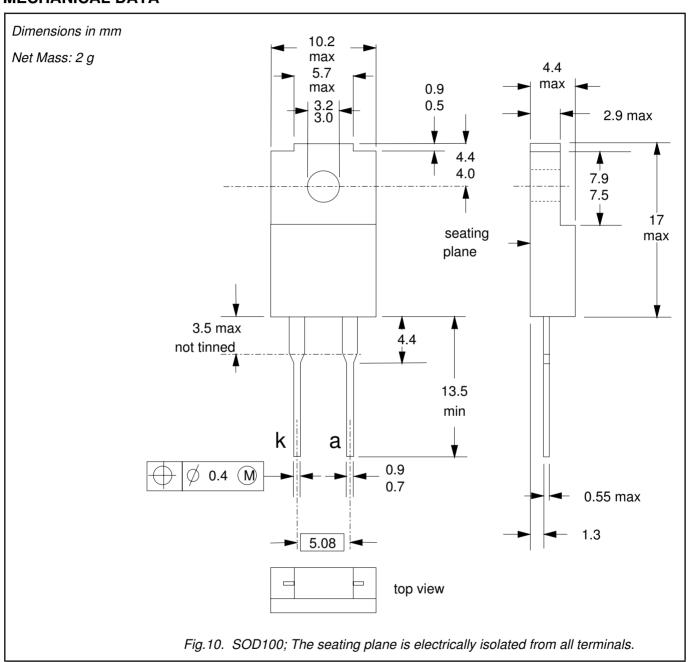


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MECHANICAL DATA



- Refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

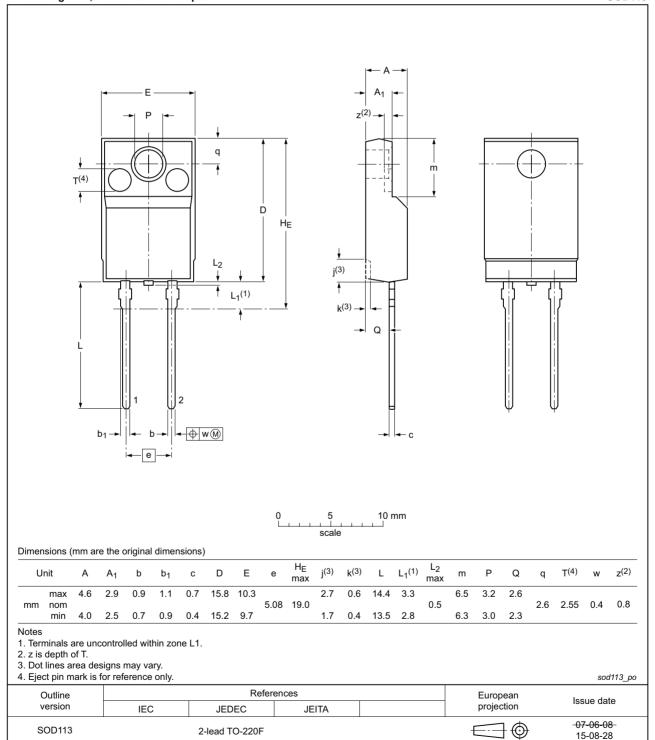
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MECHANICAL DATA

Plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 2-lead TO-220 `full pack'

SOD113



Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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